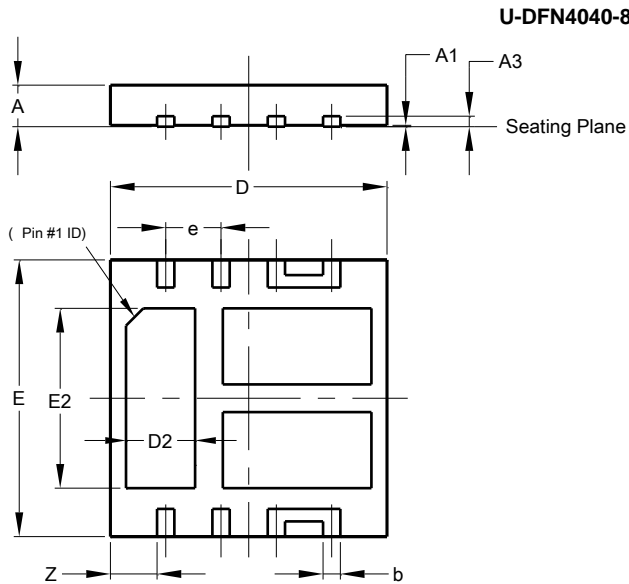
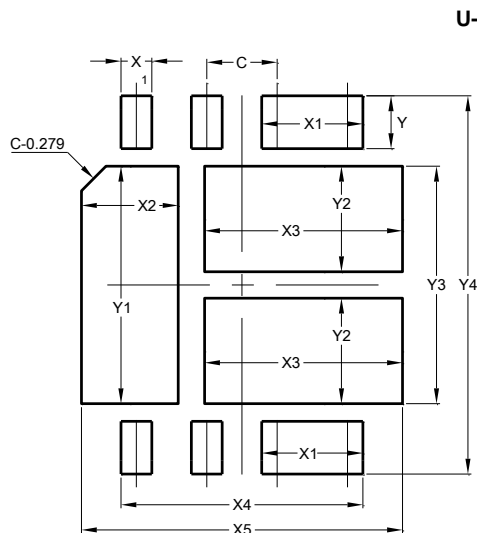


Package Outline Dimensions



U-DFN4040-8			
Dim	Min	Max	Typ
A	0.57	0.63	0.60
A1	0	0.05	0.02
A3	-	-	0.15
b	0.20	0.30	0.25
D	3.95	4.05	4.00
D1	2.05	2.25	2.15
D2	0.90	1.10	1.00
E	3.95	4.05	4.00
E1	1.00	1.20	1.10
E2	2.50	2.70	2.60
e	-	-	0.80
L	0.35	0.45	0.40
Z	-	-	0.675
All Dimensions in mm			

Suggested Pad Layout



Dimensions	Value (in mm)
C	0.800
X	0.350
X1	1.150
X2	1.100
X3	2.250
X4	2.750
X5	3.650
Y	0.600
Y1	2.700
Y2	1.200
Y3	2.700
Y4	4.300

ALL DIMENSIONS ARE NOMINAL VALUES SHOWN IN MILLIMETERS

Note: The suggested land pattern dimensions have been provided for reference only, as actual pad layouts may vary depending on application. These numbers may be modified based on user equipment capability or fabrication criteria. A more robust pattern may be desired for wave soldering and is calculated by adding 0.2 mm to the 'Z' dimension. For further information, please reference document IPC-7351A, Naming Convention for Standard SMT Land Patterns, and for International grid details, please see document IEC, Publication 97.